

Electronic Acknowledgement Receipt

EFS ID:	3926688
Application Number:	10813530
International Application Number:	
Confirmation Number:	5329
Title of Invention:	Method for fabricating a semiconductor component based on a nitride compound semiconductor
First Named Inventor/Applicant Name:	Volker Harle
Customer Number:	26161
Filer:	Marc M. Wefers/Melvin Smith
Filer Authorized By:	Marc M. Wefers
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Application Type:	Utility under 35 USC 111(a)

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Submitted with Payment	yes
Payment Type	Deposit Account
Payment was successfully received in RAM	\$ 580
RAM confirmation Number	369
Deposit Account	061050
Authorized User	

File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
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1		124060140001Reply.pdf	266715	yes	9
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	Multipart Description/PDF files in .zip description				
	Document Description		Start	End	
	Amendment/Req. Reconsideration-After Non-Final Reject		1	1	
	Claims		2	7	
	Applicant Arguments/Remarks Made in an Amendment		8	9	
Warnings:					
Information:					
2	Information Disclosure Statement (IDS) Filed (SB/08)	124060140001IDS.pdf	78067	no	2
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Warnings:					
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3	NPL Documents	JP101732229Abstract1.pdf	30509	no	1
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4	NPL Documents	JP2002208753Abstract2.pdf	26792	no	1
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5	NPL Documents	124060140001NPL.pdf	103834	no	3
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8	Foreign Reference	EP1052705foreign3.pdf	131501 07536e0154ae77b1118c2716f128d13cb1f d945c	no	15
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9	Fee Worksheet (PTO-06)	fee-info.pdf	31721 83fd5c154c23c6d0e26c75683bfd04458791 5020	no	2
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Total Files Size (in bytes):			2730763		
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